

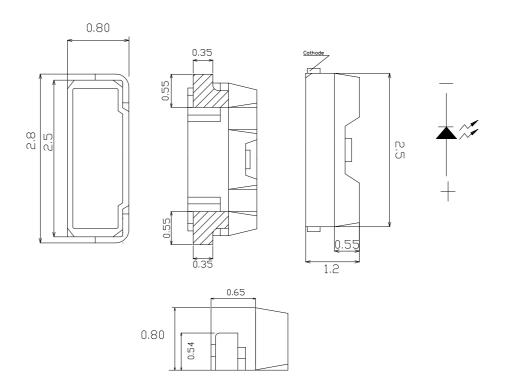
### **Features**

- · Package in 12mm tape on 7" diameter reels.
- · Compatible with automatic placement equipment.
- · Compatible with infrared and vapor phase reflow solder process.
- · I.C. compatible
- · Meet green product and Pb-free(According to RoHS)
- · Package: 2000pcs/Reel

# **Applications**

· Backlight and Indicator

## **Package Dimensions**



#### **Notes:**

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2$ mm(.0079") unless otherwise noted.
- 3. Specifications are subject to change without notice
- 4. This drawing is only for indication, not as a basis for the actual structure.

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Form No: Rev: VB2 Page: 1 of 6
Approved By: Prepared By: Date:



### FSL-2812080G-SCP2S2THQ

<b>a</b> 1	4.	$\alpha$ • 1
Sel	lection	Guide

Part No	Lens Type	Dice	Emitted Color
FSL-2812080G-SCP2S2THQ	Water Clear	InGaN	Green

# Electrical / Optical Characteristics At Ta=25°C

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Condition
Iv	Luminous Intensity	56	180	280	mcd	IF=20mA
201/2	Viewing Angle		110		deg	IF=20mA
入 Peak	Peak Emission Wavelength		570		nm	IF=20mA
λd	Dominant Wavelength	564	571	577	nm	IF=20mA
Δλ	Spectral Line Half-Width		15		nm	IF=20mA
VF	Forward Voltage	1.8	2.2	2.6	V	IF=20mA
IR	Reverse Current			10	uA	VR 5V

Note:

 $1.\,\theta 1/2$  is the angle from optical centerline where the luminous intensity is 1/2 optical centerline value

## **Absolute Maximum Ratings At Ta=25℃**

Parameter	Green	Unit	
Power Dissipation	75	mW	
Peak Forward Current[1]	80	mA	
Continuous Forward Current	30	mA	
Dreading Linear From50°C	0.4	mA/°C	
Reverse Voltage	5	V	
Electrostatic Discharge Threshold(HBM)	bischarge Threshold(HBM) 2000		
Operating Temperature Range	-55°C to + 85°C		
Storage Temperature Range	-55°C to + 85°C		
Soldering Condition	260℃ For5 Seconds		

Note:

1. 1/10DutyCycle,0.1msPulseWidth

Form No: Rev: VB2 Page: 2 of 6 Approved By: Date:



## Electrical Optical Characteristics Curves At Ta=25°C

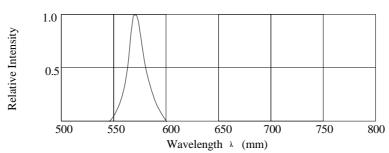
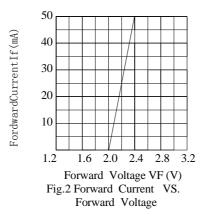
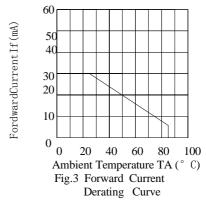
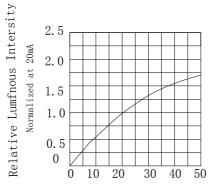
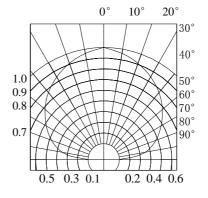


Fig.1 Rekative Intensity vs. Wavekength









Forward Current (mA)
Fig.4 Relative Luminous
Intensity vs. Forward Current

Fig.6 Spatial Distribution

Form No: Rev: VB2 Page: 3 of 6 Approved By: Prepared By: Date:





# **Bin Range Of Luminous Intensity**

Symbol	Bin Code	Min.	Max.	Unit	Condition
Iv	LP	56	72	mcd	IF=20mA
	LQ	72	112		
	LR	112	180		
	LS	180	280		

# **Bin Range Of Forward Voltage**

Symbol	Bin Code	Min.	Max.	Unit	Condition
VF	V2	1.8	2.0	V	IF=20mA
	V3	2.0	2.2		
	V4	2.2	2.4		
	V5	2.4	2.6		

## **Bin Range Of Dominate Wavelength**

	0				
Symbol	Bin Code	Min.	Max.	Unit	Condition
λd	DB	564	567	nm	IF=20mA
	DC	567	571		
	DD	570	574		
	DE	574	577		

#### Notes:

1. Tolerance of Luminous Intensity +/-20%

2. Tolerance of Forward Voltage  $\pm -0.2V$ 

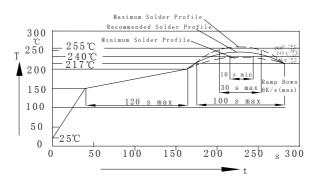
3. Tolerance of the Dominate Wavelength +/- 2nm

Rev:VB2Form No: Page: 4 of 6 Date:

Prepared By: Approved By:



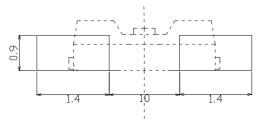
### **SMT Reflow Soldering Instructions**



#### Notes:

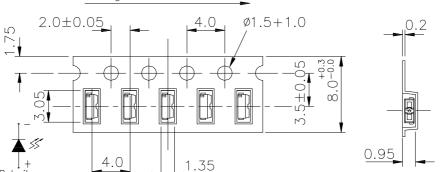
- 1. Selles gives no other assurances regarding the ability of to withstand ESD. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- 2. Reflow soldering should not be done more than two times.
- 3. Do not stress LED when soldering, and do not warp the circuit board after soldering
- 4. While using Iron, Power dissipation of Iron should be smaller than 25W, and temperature should be controllable. The work should be finished within 2 sec under 320°C for once only.

### **Recommended Soldering Pad Dimensions**



Progressive direction

### Package Specifications (Units: mm(inches))



#### Notes:

Polarity

- The LEDs should be used within a year.
- The LEDs should be kept in 5~30°C and 60% RH for less. 2.
- 3. The LEDs should be used within 24 hours, or else should be kept a 5~30°C and 30% RH or less. And LEDs should be used within 7 days after opening the package.

Form No: Rev: VB2 Page: 5 of 6 Prepared By: Date:

Approved By:





## **Reliability Test Items Conditions**

Classification	Test Item	Test Conditions	Test hours	Result
	Opertion Life	Connect with a power IF=20mA Ta=Under room temperature	1000Hrs	0/20
F .	Hige Temperature High Humidity	Ta=+65°C±5°C RH=90%-95%	240Hrs	0/20
Endurance Test	Hige Temperature Storage	High Ta=+85°C±5°C	1000Hrs	0/20
	Low Temperature Storage	Low Ta=-35°C±5°C Test time=1000hrs	1000Hrs	0/20
	Temperature Cycling	-45°C∼+105°C 15min 5min 15min	300 Cycles	0/20
Environmental	Thermal Shock	-35°C~±5°C~+85°C~±5°C 5min 10sec 5min	300 Cycles	0/20
Test	Solder Resistance	Preheating: 120°C-150°C, within 2 minutes. Operation heating: 260°C (Max.), within 5 seconds (Max.)	5Cycles	0/20

# Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	V <sub>F</sub> (V)	IF=20mA	Over U×1.2
Rvevrse current	Ir(µA)	V <sub>R</sub> =5V	Over U×2
Luminous intensity	Iv(mcd)	IF=20mA	Below S×0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Meansurment shall be taken between 2 hours after the test pieces have been returned to normal ambient conditions after completion of each test.

Form No: Rev: VB2 Page: 6 of 6
Approved By: Prepared By: Date: